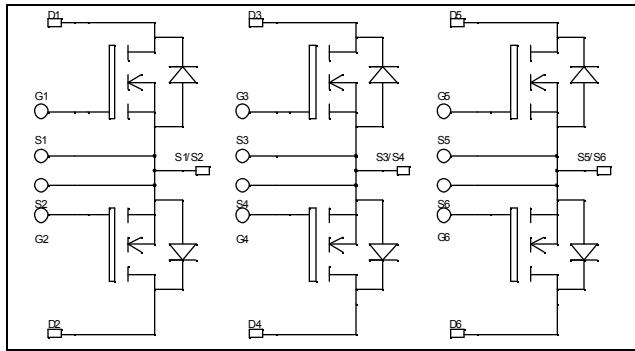


**Triple dual common source
MOSFET Power Module**

V_{DSS} = 75V
R_{DSon} = 4.2mΩ max @ T_j = 25°C
I_D = 120A @ T_c = 25°C

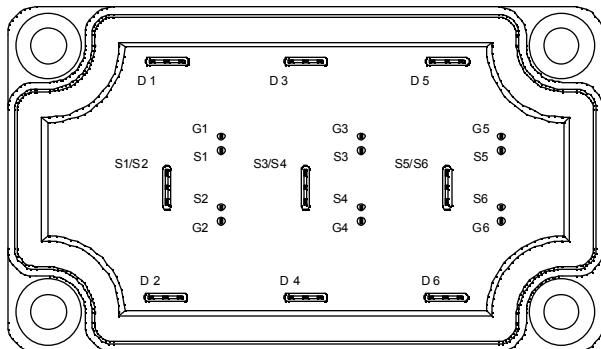


Application

- AC Switches
- Switched Mode Power Supplies
- Uninterruptible Power Supplies

Features

- Power MOSFETs
 - Low R_{DSon}
 - Low input and Miller capacitance
 - Low gate charge
 - Avalanche energy rated
 - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
 - Symmetrical design
 - Lead frames for power connections
- High level of integration



Absolute maximum ratings

| Symbol | Parameter | Max ratings | Unit |
|-------------------|---|-----------------------|------|
| V _{DSS} | Drain - Source Breakdown Voltage | 75 | V |
| I _D | Continuous Drain Current | T _c = 25°C | 120 |
| | | T _c = 80°C | 90 |
| I _{DM} | Pulsed Drain current | 250 | |
| V _{GS} | Gate - Source Voltage | ±30 | V |
| R _{DSon} | Drain - Source ON Resistance | 4.5 | mΩ |
| P _D | Maximum Power Dissipation | T _c = 25°C | 138 |
| I _{AR} | Avalanche current (repetitive and non repetitive) | 75 | A |
| E _{AR} | Repetitive Avalanche Energy | 50 | |
| E _{AS} | Single Pulse Avalanche Energy | 1500 | mJ |

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

| Symbol | Characteristic | Test Conditions | | Min | Typ | Max | Unit |
|--------------|---------------------------------|---|---------------------------|-----|-----|-----------|------------------|
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{GS} = 0\text{V}$, $V_{DS} = 75\text{V}$ | $T_j = 25^\circ\text{C}$ | | | 100 | μA |
| | | $V_{GS} = 0\text{V}$, $V_{DS} = 60\text{V}$ | $T_j = 125^\circ\text{C}$ | | | 250 | |
| $R_{DS(on)}$ | Drain – Source on Resistance | $V_{GS} = 10\text{V}$, $I_D = 60\text{A}$ | | | 4.2 | 4.5 | $\text{m}\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 1\text{mA}$ | | 2 | | 4 | V |
| I_{GSS} | Gate – Source Leakage Current | $V_{GS} = \pm 30\text{ V}$, $V_{DS} = 0\text{V}$ | | | | ± 100 | nA |

Dynamic Characteristics

| Symbol | Characteristic | Test Conditions | | Min | Typ | Max | Unit |
|--------------|------------------------------|---|--|------|-----|-----|---------------|
| C_{iss} | Input Capacitance | $V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$ | | 4530 | | | pF |
| C_{oss} | Output Capacitance | | | 1080 | | | |
| C_{rss} | Reverse Transfer Capacitance | | | 450 | | | |
| Q_g | Total gate Charge | $V_{GS} = 10\text{V}$ $V_{Bus} = 60\text{V}$ $I_D = 120\text{A}$ | | 153 | | | nC |
| Q_{gs} | Gate – Source Charge | | | 25 | | | |
| Q_{gd} | Gate – Drain Charge | | | 82 | | | |
| $T_{d(on)}$ | Turn-on Delay Time | Inductive switching @ 125°C $V_{GS} = 15\text{V}$ $V_{Bus} = 40\text{V}$ $I_D = 120\text{A}$ $R_G = 5\Omega$ | | 35 | | | ns |
| T_r | Rise Time | | | 60 | | | |
| $T_{d(off)}$ | Turn-off Delay Time | | | 100 | | | |
| T_f | Fall Time | | | 65 | | | |
| E_{on} | Turn-on Switching Energy | Inductive switching @ 25°C $V_{GS} = 15\text{V}$, $V_{Bus} = 40\text{V}$ $I_D = 120\text{A}$, $R_G = 5\Omega$ | | 290 | | | μJ |
| E_{off} | Turn-off Switching Energy | | | 317 | | | |
| E_{on} | Turn-on Switching Energy | Inductive switching @ 125°C $V_{GS} = 15\text{V}$, $V_{Bus} = 40\text{V}$ $I_D = 120\text{A}$, $R_G = 5\Omega$ | | 319 | | | μJ |
| E_{off} | Turn-off Switching Energy | | | 336 | | | |

Source - Drain diode ratings and characteristics

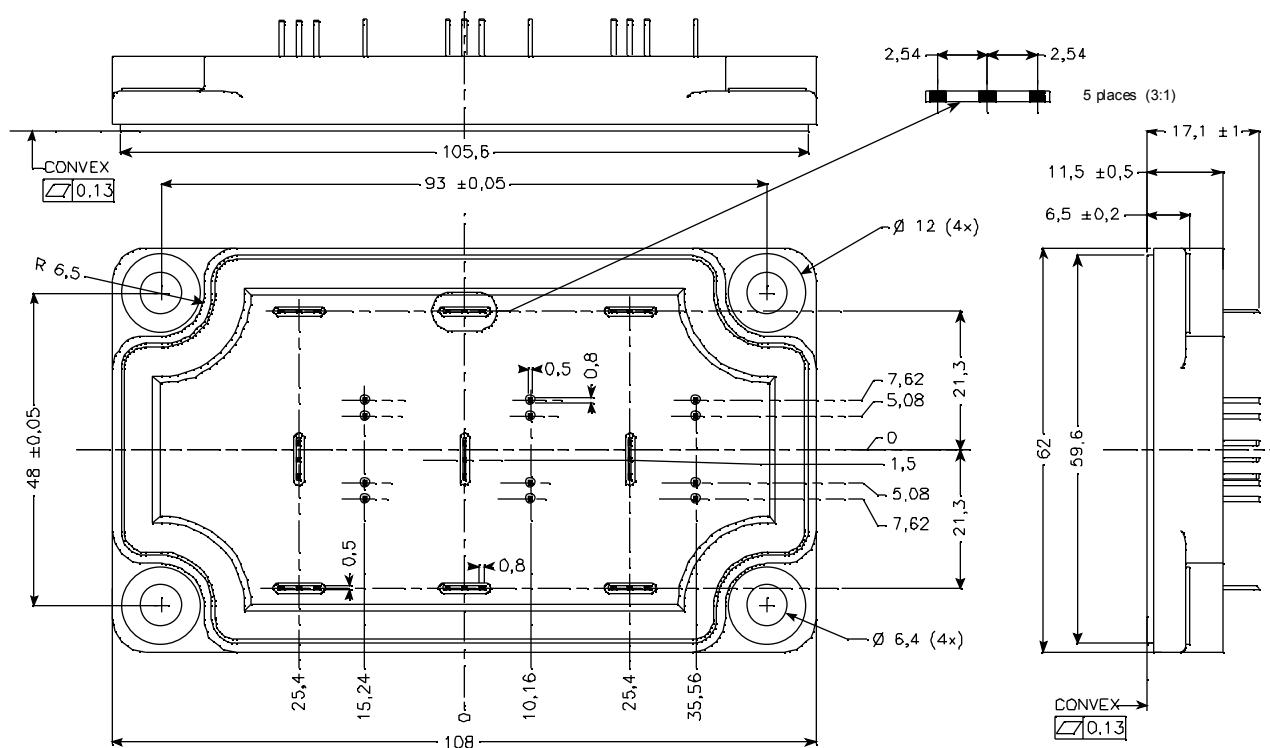
| Symbol | Characteristic | Test Conditions | | Min | Typ | Max | Unit |
|----------|---|---|--------------------------|-----|-----|-----|---------------|
| I_S | Continuous Source current (Body diode) | | $T_c = 25^\circ\text{C}$ | | | 120 | A |
| | | | $T_c = 80^\circ\text{C}$ | | | 90 | |
| V_{SD} | Diode Forward Voltage | $V_{GS} = 0\text{V}$, $I_S = -120\text{A}$ | | | | 1.3 | V |
| dv/dt | Peak Diode Recovery ① | | | | | 6 | V/ns |
| t_{rr} | Reverse Recovery Time | $I_S = -120\text{A}$ $V_R = 40\text{V}$ $dI_S/dt = 100\text{A}/\mu\text{s}$ | $T_j = 25^\circ\text{C}$ | | 100 | 200 | ns |
| Q_{rr} | Reverse Recovery Charge | | $T_j = 25^\circ\text{C}$ | | 300 | | nC |

 ① dv/dt numbers reflect the limitations of the circuit rather than the device itself.

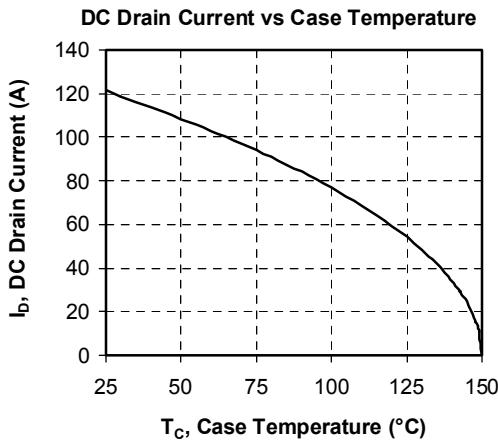
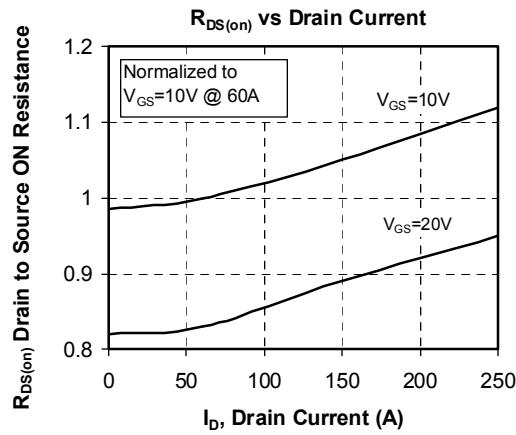
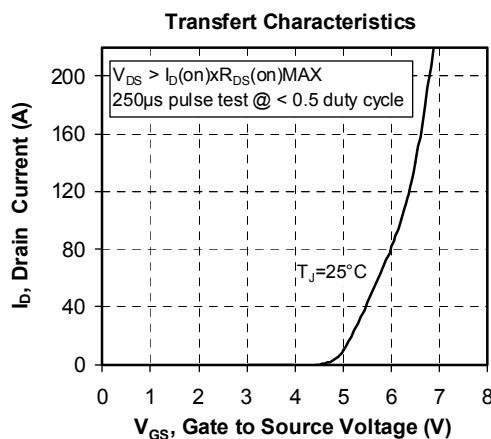
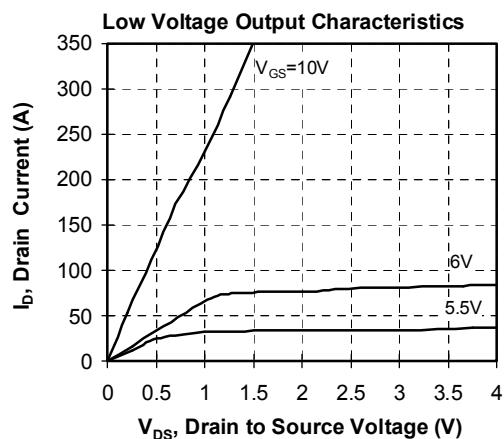
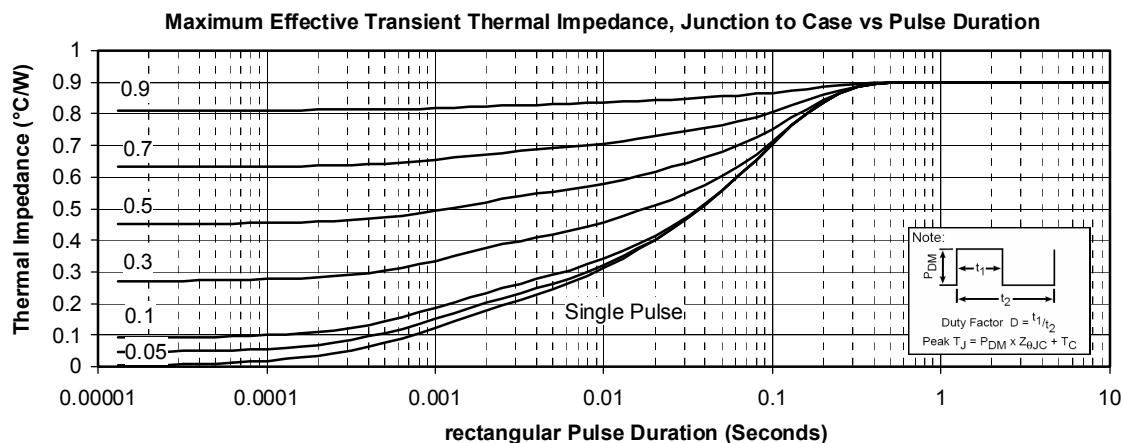
 $I_S \leq -120\text{A}$ $di/dt \leq 700\text{A}/\mu\text{s}$ $V_R \leq V_{DSS}$ $T_j \leq 150^\circ\text{C}$

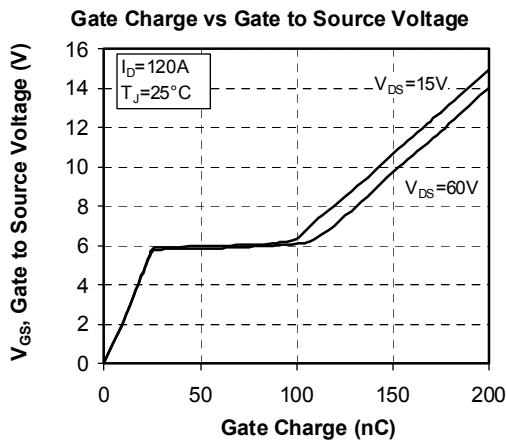
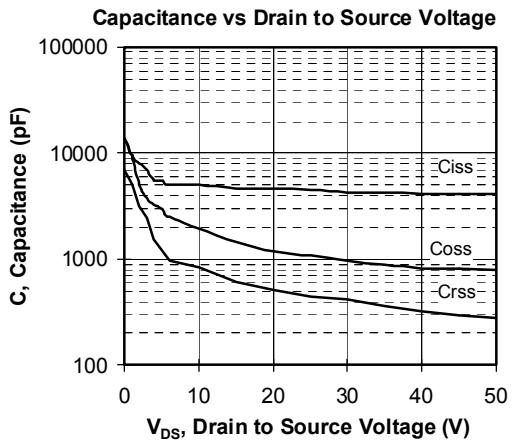
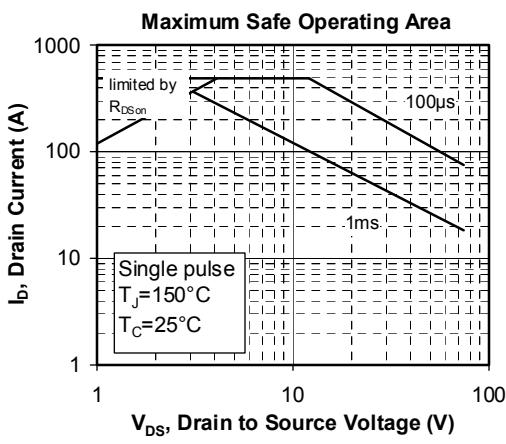
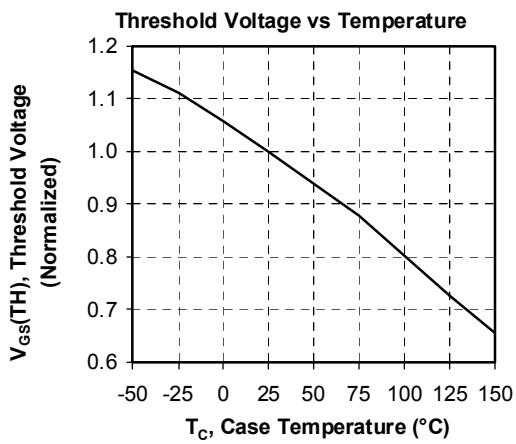
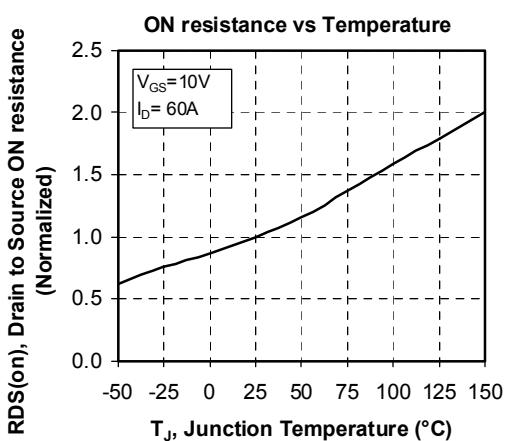
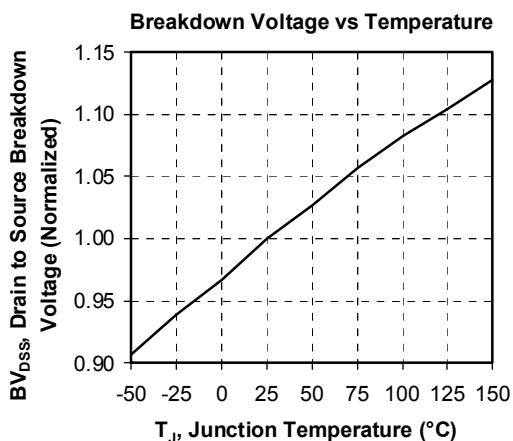
Thermal and package characteristics
Symbol **Characteristic**
Min **Typ** **Max** **Unit**

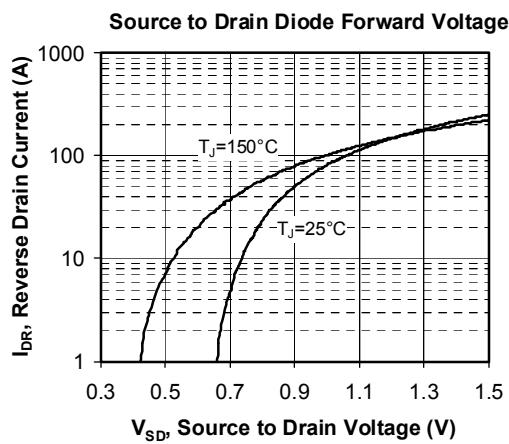
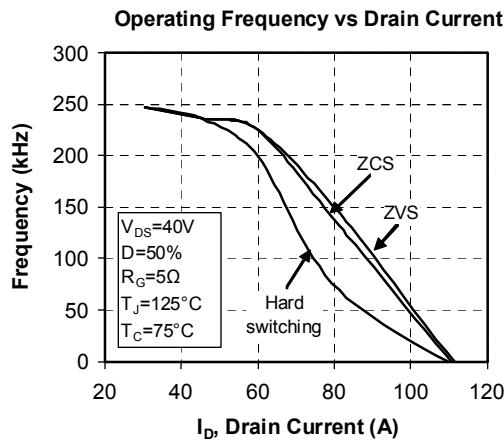
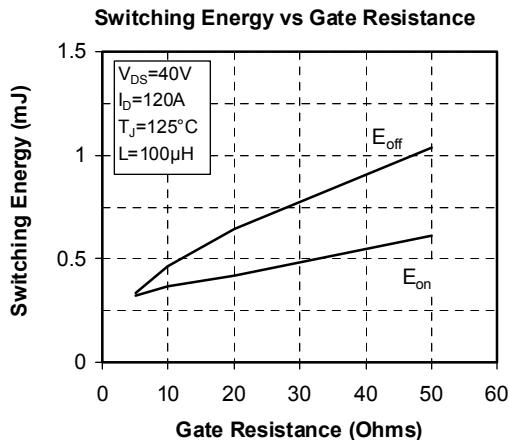
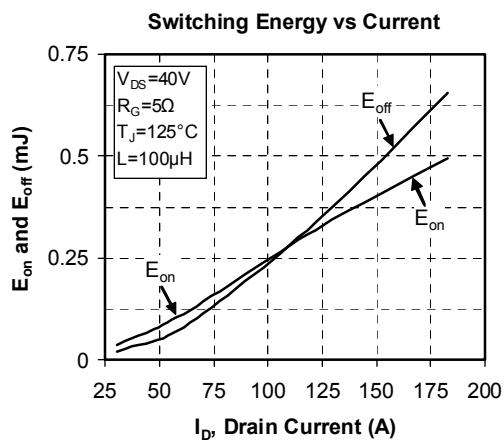
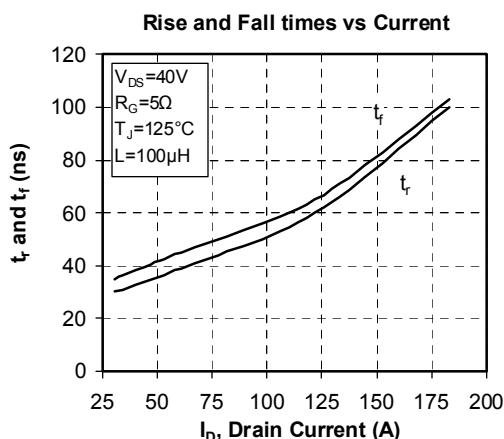
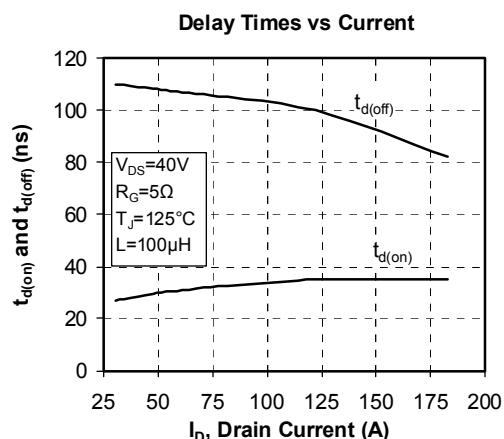
| | | | | | | |
|------------|--|-------------|----|------|-----|-----------------------------|
| R_{thJC} | Junction to Case Thermal Resistance | | | | 0.9 | $^{\circ}\text{C}/\text{W}$ |
| V_{ISOL} | RMS Isolation Voltage, any terminal to case t = 1 min, $I_{isol} < 1\text{mA}$, 50/60Hz | | | 2500 | | V |
| T_J | Operating junction temperature range | | | -40 | 150 | $^{\circ}\text{C}$ |
| T_{STG} | Storage Temperature Range | | | -40 | 125 | |
| T_C | Operating Case Temperature | | | -40 | 100 | |
| Torque | Mounting torque | To heatsink | M6 | 3 | 5 | N.m |
| Wt | Package Weight | | | | 250 | g |

SP6-P Package outline (dimensions in mm)

 See application note 1902 - Mounting Instructions for SP6-P (12mm) Power Modules on www.microsemi.com

Typical Performance Curve







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